

## SOT-323 Plastic-Encapsulate MOSFETS

P-Channel 20-V(D-S) MOSFET

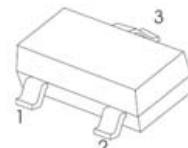
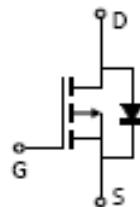
### FEATURE

- TrenchFET Power MOSFET

### APPLICATIONS

- Load Switch for Portable Devices
- DC/DC Converter

### MARKING: A1S



**SOT-323**

1. GATE      2. SOURCE      3. DRAIN

### Maximum ratings ( $T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	-20	V
Gate-Source Voltage	$V_{GS}$	$\pm 8$	
Continuous Drain Current	$I_D$	-2.1	A
Pulsed Drain Current	$I_{DM}$	-4.8	
Continuous Source-Drain Diode Current	$I_S$	-0.72	
Maximum Power Dissipation	$P_D$	0.35	W
Thermal Resistance from Junction to Ambient( $t \leq 5\text{s}$ )	$R_{\theta JA}$	357	$^\circ\text{C/W}$
Junction Temperature	$T_J$	150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-55 ~ +150	

**Electrical characteristics ( $T_a=25^\circ\text{C}$  unless otherwise noted)**

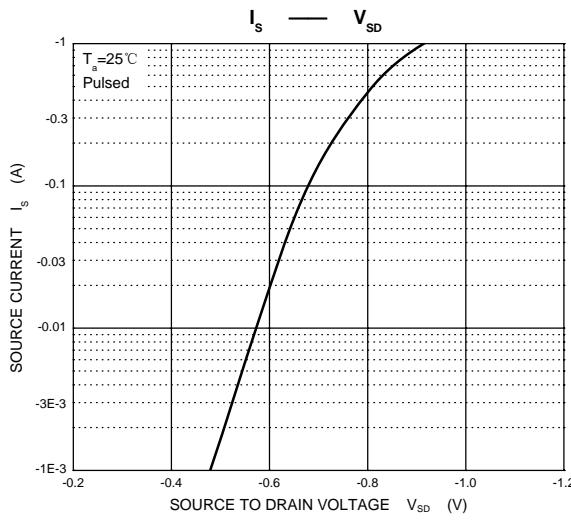
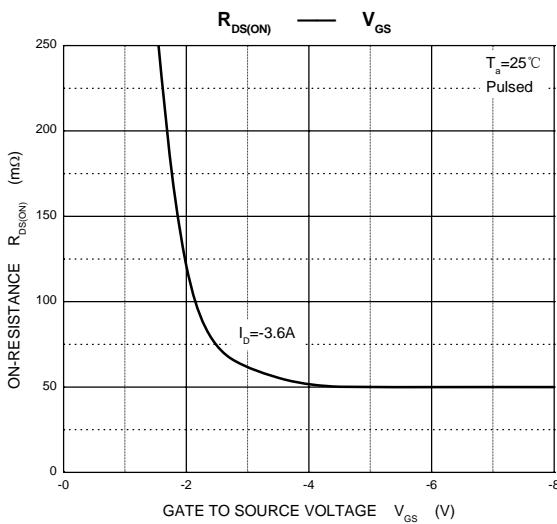
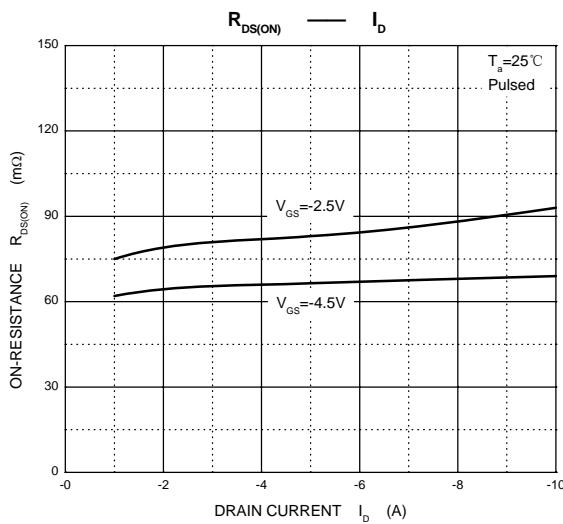
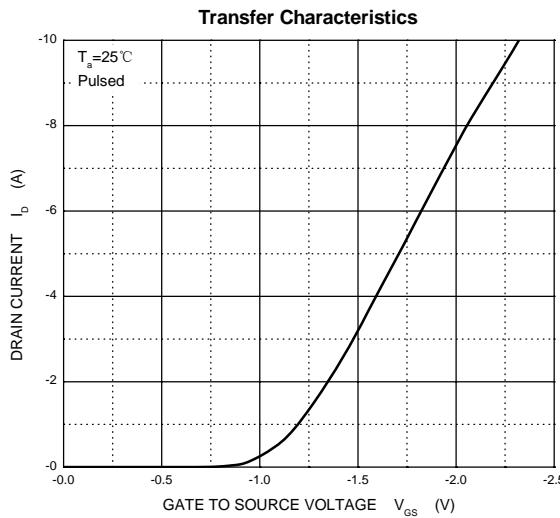
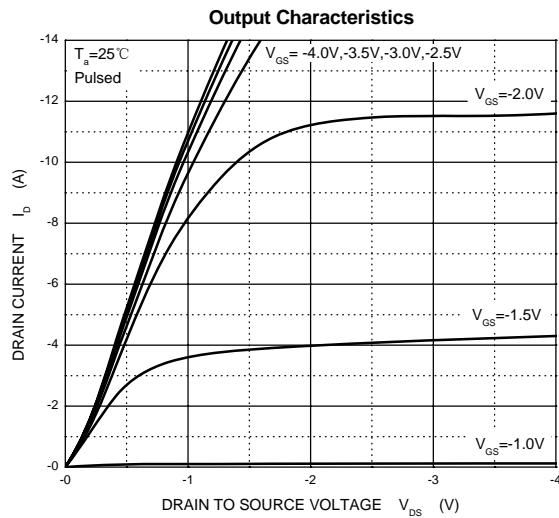
Parameter	Symbol	Test Condition	Min	Typ	Max	Units
<b>Static</b>						
Drain-source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = -250\mu\text{A}$	-20			V
Gate-source threshold voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = -250\mu\text{A}$	-0.4		-1	
Gate-source leakage	$I_{\text{GSS}}$	$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = \pm 8\text{V}$			$\pm 100$	nA
Zero gate voltage drain current	$I_{\text{DSS}}$	$V_{\text{DS}} = -20\text{V}, V_{\text{GS}} = 0\text{V}$			-1	$\mu\text{A}$
Drain-source on-state resistance <sup>a</sup>	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = -4.5\text{V}, I_D = -1\text{A}$		0.090	0.120	$\Omega$
		$V_{\text{GS}} = -2.5\text{V}, I_D = -0.5\text{A}$		0.110	0.170	
Forward transconductance <sup>a</sup>	$g_{\text{fs}}$	$V_{\text{DS}} = -5\text{V}, I_D = -1.8\text{A}$		6.5		S
<b>Dynamic<sup>b</sup></b>						
Input capacitance	$C_{\text{iss}}$	$V_{\text{DS}} = -10\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		405		pF
Output capacitance	$C_{\text{oss}}$			75		
Reverse transfer capacitance	$C_{\text{rss}}$			55		
Total gate charge	$Q_g$	$V_{\text{DS}} = -10\text{V}, V_{\text{GS}} = -4.5\text{V}, I_D = -3\text{A}$		5.5	10	nC
				3.3	6	
Gate-source charge	$Q_{\text{gs}}$	$V_{\text{DS}} = -10\text{V}, V_{\text{GS}} = -2.5\text{V}, I_D = -3\text{A}$		0.7		
Gate-drain charge	$Q_{\text{gd}}$			1.3		
Gate resistance	$R_g$	$f = 1\text{MHz}$		6.0		$\Omega$
Turn-on delay time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = -10\text{V}, R_L = 10\Omega, I_D = -1\text{A}, V_{\text{GEN}} = -4.5\text{V}, R_g = 1\Omega$		11	20	ns
Rise time	$t_r$			35	60	
Turn-off delay time	$t_{\text{d}(\text{off})}$			30	50	
Fall time	$t_f$			10	20	
<b>Drain-source body diode characteristics</b>						
Continuous source-drain diode current	$I_S$	$T_c = 25^\circ\text{C}$			-1.3	A
Pulse diode forward current <sup>a</sup>	$I_{\text{SM}}$				-10	
Body diode voltage	$V_{\text{SD}}$	$I_S = -0.7\text{A}$		-0.8	-1.2	V

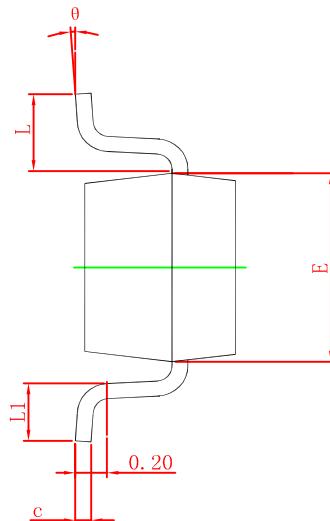
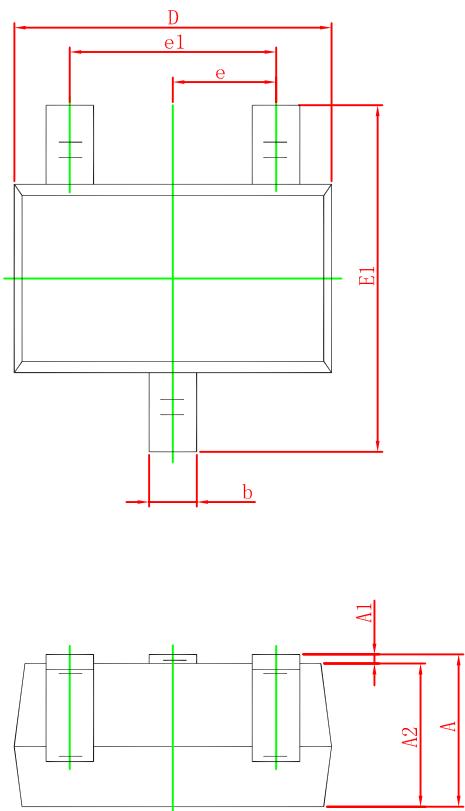
**Notes :**

a.Pulse Test : Pulse Width < 300μs, Duty Cycle ≤2%.

b.Guaranteed by design, not subject to production testing.

## Typical Characteristics



**SOT-323 Package Outline Dimensions**


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.200	0.400	0.008	0.016
c	0.080	0.150	0.003	0.006
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.450	0.085	0.096
e	0.650 TYP.		0.026 TYP.	
e1	1.200	1.400	0.047	0.055
L	0.525 REF.		0.021 REF.	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°